TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# TC74AC174P, TC74AC174F, TC74AC174FN, TC74AC174FT

#### HEX D-TYPE FLIP FLOP WITH CLEAR

The TC74AC174 is an advanced high speed CMOS HEX D-TYPE FLIP FLOP fabricated with silicon gate and double layer metal wiring C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Information signals applied to D inputs are transferred to the Q output on the positive going edge of the clock pulse.

When the  $\overline{\text{CLR}}$  input is held low, the Q output are in the low logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **FEATURES:**

• High Speed------f<sub>MAX</sub> = 180MHz(typ.)

at  $V_{CC} = 5V$ 

- Low Power Dissipation ·······  $I_{CC} = 8\mu A(Max.)$  at  $Ta = 25^{\circ}C$
- High Noise Immunity  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (Min.)
- Symmetrical Output Impedance···|  $I_{OH}$  | =  $I_{OL}$  = 24mA(Min.)

Capability of driving  $50\Omega$ 

transmission lines.

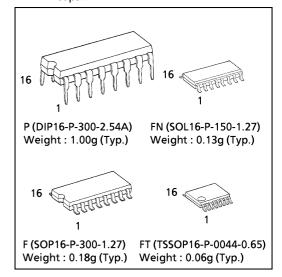
- Balanced Propagation Delays  $\cdots t_{pLH} \simeq t_{pHL}$
- Wide Operating Voltage Range ···· V<sub>CC</sub> (opr) = 2V ~ 5.5V
- Pin and Function Compatible with 74F174

## TRUTH TABLE

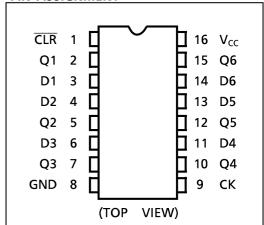
INPUTS			OUTPUTS	FUNCTION		
CLR	D	CK	Q	FUNCTION		
L	Х	Х	L	CLEAR		
Н	L		L	_		
Н	Н		Н	_		
Н	Х	٦ <u>ـ</u>	Qn	NO CHANGE		

X : Don't Care

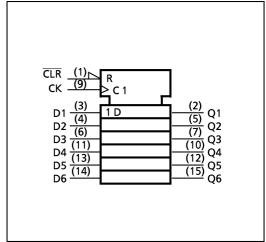
(Note) The JEDEC SOP (FN) is not available in Japan.



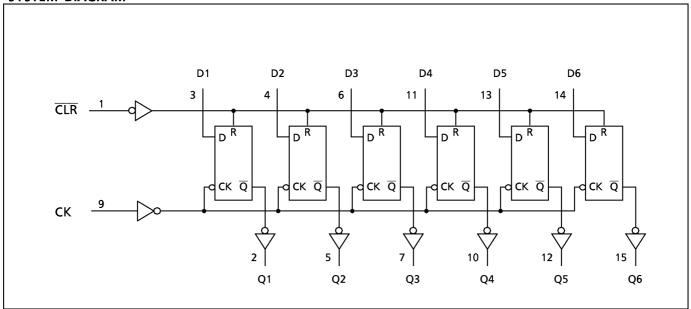
## PIN ASSIGNMENT



### IEC LOGIC SYMBOL



## SYSTEM DIAGRAM



### **ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V <sub>cc</sub>	-0.5~7.0	V
DC Input Voltage	V <sub>IN</sub>	$-0.5 \sim V_{CC} + 0.5$	V
DC Output Voltage	V <sub>OUT</sub>	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	I <sub>IK</sub>	± 20	mΑ
Output Diode Current	I <sub>OK</sub>	± 50	mΑ
DC Output Current	I <sub>OUT</sub>	± 50	mΑ
DC V <sub>cc</sub> /Ground Current	I <sub>cc</sub>	± 150	mΑ
Power Dissipation	P <sub>D</sub>	500 (DIP)*/ 180 (SOP/TSSOP)	mW
Storage Temperature	T <sub>stg</sub>	<b>−65~150</b>	°C

\*500mW in the range of Ta =  $-40^{\circ}$ C ~65°C. From Ta = 65°C to 85°C a derating factor of -10mW/°C should be applied up to 300mW.

### **RECOMMENDED OPERATING CONDITIONS**

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	$V_{CC}$	2.0~5.5	V
Input Voltage	V <sub>IN</sub>	0~V <sub>cc</sub>	V
Output Voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	٧
Operating Temperature	T <sub>opr</sub>	<b>−40~85</b>	°C
Input Rise and Fall Time	dt/dV	$0 \sim 100 \text{ (Vcc} = 3.3 \pm 0.3 \text{V)}$ $0 \sim 20 \text{ (Vcc} = 5 \pm 0.5 \text{V)}$	ns / V

## DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION		V <sub>CC</sub>	Ta = 25°C			$Ta = -40 \sim 85^{\circ}C$		UNIT
TARAMETER STIMBOL		1231 CO	1231 CONDITION		MIN.	TYP.	MAX.	MIN.	MAX.	CIVII
High - Level Input Voltage	V <sub>IH</sub>				1.50 2.10 3.85			1.50 2.10 3.85		٧
Low - Level Input Voltage	VIL		2.0 3.0 5.5	_ _ _		0.50 0.90 1.65		0.50 0.90 1.65	<b>V</b>	
High - Level Output Voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -50\mu A$	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5		1.9 2.9 4.4		\ \ \
			$I_{OH} = -4mA$ $I_{OH} = -24mA$ $I_{OH} = -75mA*$	3.0 4.5 5.5	2.58 3.94 —		1 1 1	2.48 3.80 3.85		V
Low - Level	.,,	V <sub>I N</sub> =	$I_{OL} = 50 \mu A$	2.0 3.0 4.5	1 1 1	0.0 0.0 0.0	0.1 0.1 0.1	111	0.1 0.1 0.1	<b>&gt;</b>
Output Voltage	V <sub>OL</sub> V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 12mA$ $I_{OL} = 24mA$ $I_{OL} = 75mA*$	3.0 4.5 5.5		111	0.36 0.36 —	111	0.44 0.44 1.65	V	
Input Leakage Current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or GND		5.5	_	ı	± 0.1	_	± 1.0	
Quiescent Supply Current	I <sub>cc</sub>	$V_{IN} = V_{CC}$ or GN	ID	5.5	_	_	8.0	_	80.0	$\mu$ A

<sup>\* :</sup> This spec indicates the capability of driving  $50\Omega$  transmission lines. One output should be tested at a time for a 10ms maximum duration.

## TIMING REQUIREMENTS (Input $t_r = t_f = 3ns$ )

PARAMETER	SYMBOL	TEST CONDI	ΓΙΟΝ	Ta = 25°C	Ta = −40~85°C	UNIT
PARAMETER	STIVIBOL		V <sub>CC</sub> (V)	LIMIT	LIMIT	UNIT
Minimum Pulse Width ( CK )	t <sub>W (L)</sub> t <sub>W (H)</sub>		3.3 ± 0.3 5.0 ± 0.5	7.0 5.0	7.0 5.0	
Minimum Pulse Width (CLR)	t <sub>W (L)</sub>		3.3 ± 0.3 5.0 ± 0.5	7.0 5.0	7.0 5.0	
Minimum Set - up Time	t <sub>s</sub>		3.3 ± 0.3 5.0 ± 0.5	7.0 4.0	7.0 4.0	ns
Minimum Hold Time	t <sub>h</sub>		3.3 ± 0.3 5.0 ± 0.5	1.0 1.0	1.0 1.0	
Minimum Removal Time ( CLR )	t <sub>rem</sub>		3.3 ± 0.3 5.0 ± 0.5	6.0 3.5	6.0 3.5	

#### AC ELECTRICAL CHARACTERISTICS ( $C_L = 50pF$ , $R_L = 500\Omega$ , Input $t_r = t_f = 3ns$ )

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PARAMETER	SYMBOL	TEST CONDITION		-	Ta = 25°C	:	Ta = −40~85°C		UNIT
PARAIVIETER	STIVIBOL		V <sub>CC</sub> (V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
Propagation Delay Time (CK-Q)	t <sub>pLH</sub> t <sub>pHL</sub>		3.3 ± 0.3 5.0 ± 0.5	_	8.5 6.7	14.4 9.6	1.0 1.0	16.6 11.0	
Propagation Delay Time ( CLR — Q )	t <sub>pHL</sub>		3.3 ± 0.3 5.0 ± 0.5		8.2 6.3	13.9 9.0	1.0 1.0	16.0 10.4	ns
Maximum Clock Frequency	f <sub>MAX</sub>		3.3 ± 0.3 5.0 ± 0.5	60 90	110 150	_	60 90	_	MHz
Input Capacitance	C <sub>IN</sub>			-	5	10	_	10	
Power Dissipation Capacitance	C <sub>PD</sub> (1)		·	_	74	_	_	_	pF

Note (1) C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

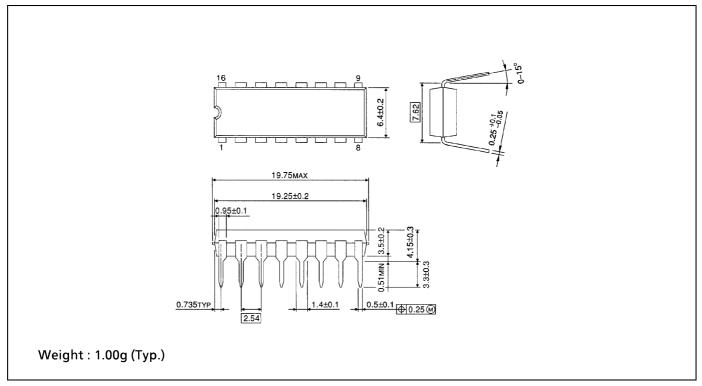
Average operating current can be obtained by the equation:

 $I_{CC}(opr.) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 6 (per F/F)$ 

And the total CPD when n pcs of Flip Flop operate can be gained by the following equation  $C_{PD}$  (total) = 34 + 40·n

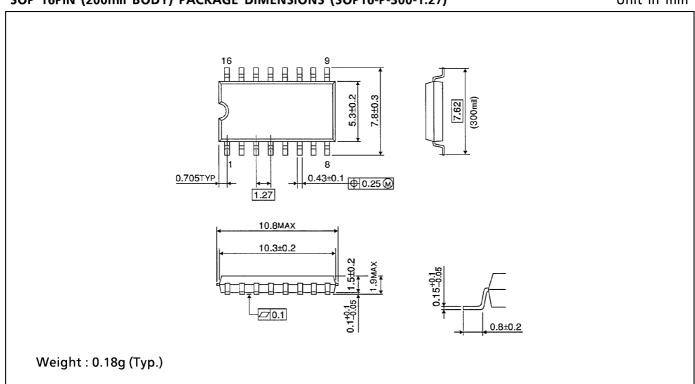
## DIP 16PIN PACKAGE DIMENSIONS (DIP16-P-300-2.54A)

Unit in mm



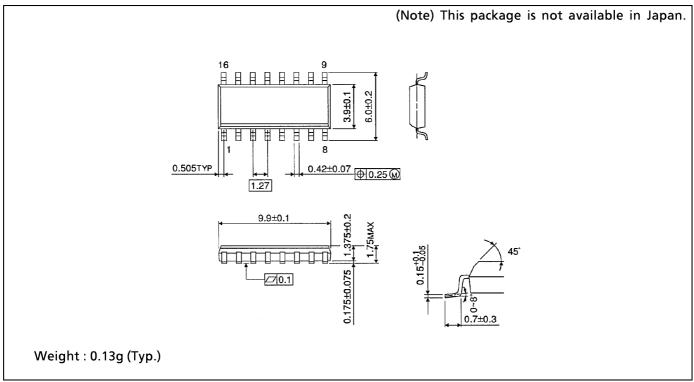
## SOP 16PIN (200mil BODY) PACKAGE DIMENSIONS (SOP16-P-300-1.27)

Unit in mm



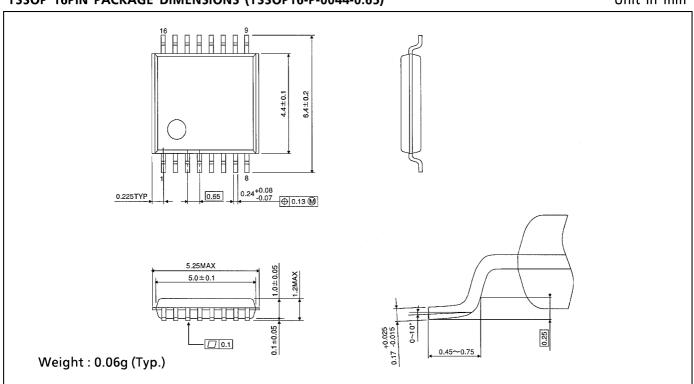
## SOP 16PIN (150mil BODY) PACKAGE DIMENSIONS (SOL16-P-150 -1.27)

Unit in mm



### TSSOP 16PIN PACKAGE DIMENSIONS (TSSOP16-P-0044-0.65)

Unit in mm



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